



ES3A/AB - ES3D/DB

3.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 100A Peak
- Ideally Suited for Automated Assembly
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SMB/SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (23)
- Polarity: Cathode Band or Cathode Notch
- SMB Weight: 0.093 grams (Approximate)
- SMC Weight: 0.21 grams (Approximate)



Top View



Ordering Information (Note 4)

Part Number	Case	Packaging
ES3x-13-F	SMC	3000/Tape & Reel
ES3xB-13-F	SMB	3000/Tape & Reel

* x = Device type, e.g. ES3A-13-F (SMC package); ES3AB-13-F (SMB package).

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

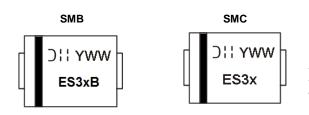
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



ES3x = Product Type Marking Code, ex: ES3A (SMC Package) ES3xB = Product Type Marking Code, ex: ES3AB (SMB Package) O!! = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 0 for 2020) WW = Week Code (01 to 53)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	ES3A/AB	ES3B/BB	ES3C/CB	ES3D/DB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 5)	V _{RRM} Vrwm Vr	50	100	150	200	V
RMS Reverse Voltage	VR(RMS)	35	70	105	140	V
Average Rectified Output Current $@ T_T = +100^{\circ}C$	lo		3	.0		Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}		1(00		А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal	R _{θJT}	10	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	50	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

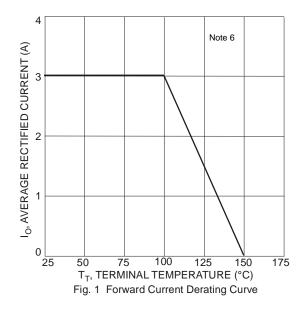
Characteristic		Symbol	Value	Unit
Maximum Forward Voltage	@ I _F = 3.0A	Vfm	0.9	V
Peak Reverse Current at Rated DC Blocking Voltage (Note 5)	@ T _A = +25°C @ T _A = +125°C		10 500	μA
Maximum Reverse Recovery Time (Note 7)		t _{RR}	25	ns
Typical Total Capacitance (Note 8)		Ст	45	pF

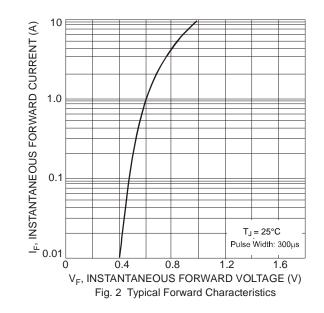
Notes: 5. Short duration pulse test used to minimize self-heating effect.

6. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

7. Measured with I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A. See Figure 5.

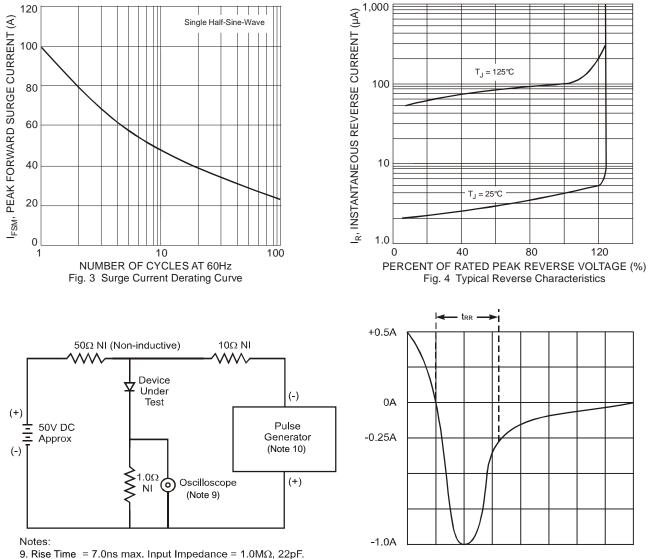
8. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.





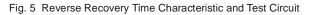


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10. Rise Time = 10ns max. Input Impedance = 50Ω .

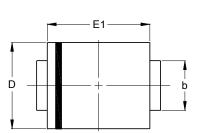
Set time base for 50/100 ns/cm

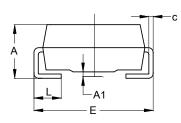




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

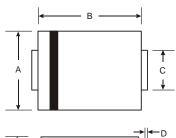


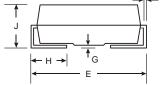


SMB				
Dim	Min	Max		
Α	2.00	2.50		
A1	0.05	0.20		
b	1.96	2.21		
С	0.15	0.31		
D	3.30	3.94		
Е	5.00	5.59		
E1	4.06	4.57		
L	0.76	1.52		
All Dimensions in mm				

SMC

SMB



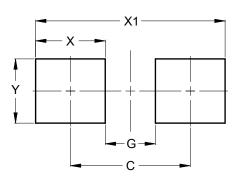


SMC Max Dim Min 5.59 6.22 Α В 6.60 7.11 С 2.75 3.18 0.15 7.75 D 0.31 Ε 8.13 G 0.10 0.20 Η 0.76 1.52 2.00 J 2.50 All Dimensions in mm



Suggested Pad Layout

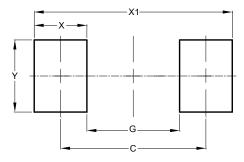
Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	4.30
G	1.80
Х	2.50
X1	6.80
Ý	2.30

SMC

SMB



Dimensions	Value		
Dimensions	(in mm)		
С	6.90		
G	4.40		
Х	2.50		
X1	9.40		
Y	3.30		



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